



A Product Line of Diodes Incorporated

ZXTN4000Z

60V NPN LED DRIVING TRANSISTOR IN SOT89

Features

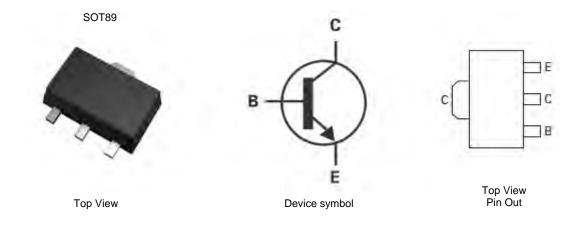
- BV_{CEO} > 60V
- Max continuous current $I_C = 1A$
- $h_{FE} > 100 @ I_C = 150mA, V_{CE} = 150mV$
- Lead Free, RoHS Compliant (Note 1)
- Halogen and Antimony Free "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Applications

LED TV backlight



- Case: SOT89
- Case material: molded Plastic. "Green" molding Compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.052 grams (Approximate)



Ordering Information (Note 3)

| Product | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|-------------|---------|--------------------|-----------------|-------------------|
| ZXTN4000ZTA | 1S7 | 7 | 12 | 1000 units |

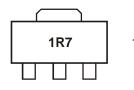
1. No purposefully added lead.

2. Diodes Inc's "Green" Policy can be found on our website at http://www.diodes.com

3. For Packaging Details, go to our website at http://www.diodes.com.

Marking Information

Notes:



1R7 = Product Type Marking Code





Maximum Ratings @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|------------------------------|------------------|-------|------|
| Collector-Base Voltage | V _{CBO} | 60 | V |
| Collector-Emitter Voltage | V _{CEO} | 60 | V |
| Emitter-Base Voltage | V _{EBO} | 7 | V |
| Continuous Collector Current | lc | 1 | A |
| Peak Pulse Current (Note 4) | I _{CM} | 3 | A |
| Base Current | IB | 500 | mA |

Thermal Characteristics @T_A = 25°C unless otherwise specified

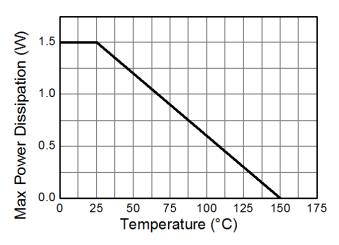
| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Note 5) | PD | 1.5 | W |
| Thermal Resistance, Junction to Ambient (Note 5) | R _{θJA} | 83 | °C/W |
| Thermal Resistance, Junction to Leads (Note 6) | R _{θJL} | 28 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C |

Notes: 4. Measured under pulsed conditions. Pulse width = 300μ s. Duty cycle $\leq 2\%$.

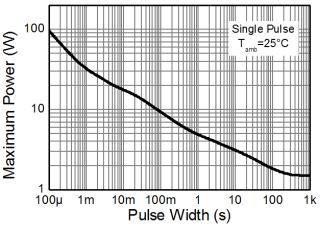
5. For a device surface mounted on 25mm X 25mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions

6. Thermal resistance from junction to solder-point (at the end of the collector lead).

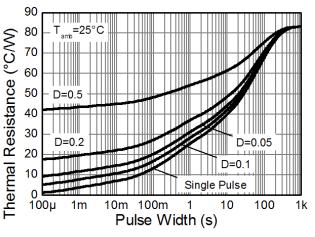
Thermal Characteristics and Derating information



Derating Curve



Pulse Power Dissipation



Transient Thermal Impedance





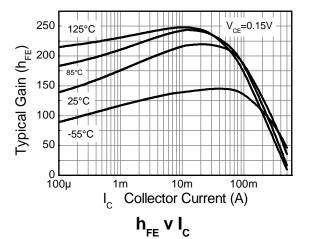
ated | **2.1.1 | 1.1** ZXTN4000Z

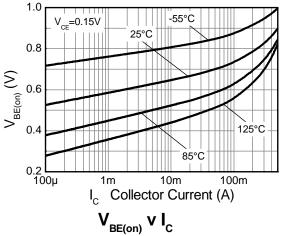
Electrical Characteristics @T_A = 25°C unless otherwise specified

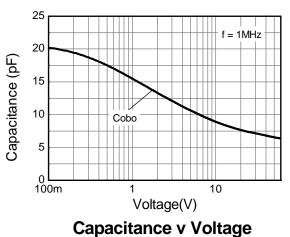
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|--|---------------------|-----------|------|------|------|--|
| Collector-Base Breakdown Voltage | BV _{CBO} | 60 | | - | V | $I_{\rm C} = 100 \mu A$ |
| Collector-Emitter Breakdown Voltage (Note 7) | BV _{CEO} | 60 | | - | V | $I_{\rm C} = 10 {\rm mA}$ |
| Emitter-Base Breakdown Voltage | BV _{EBO} | 7 | 8.3 | - | V | I _E = 100μA |
| Collector Cut-off Current | I _{CBO} | - | - | 50 | nA | $V_{CB} = 60V$ |
| Emitter Cut-off Current | I _{EBO} | - | - | 50 | nA | $V_{EB} = 7V$ |
| Static Forward Current Transfer Ratio (Note 7) | h _{FE} | 60 100 | - | - | - | $I_{C} = 85 \text{mA}, V_{CE} = 0.1 \text{V}$ $I_{C} = 150 \text{mA}, V_{CE} = 0.15 \text{V}$ |
| Base-Emitter Turn-On Voltage (Note 7) | V _{BE(on)} | - | 0.76 | 0.95 | V | $I_{\rm C} = 150 {\rm mA}, V_{\rm CE} = 0.15 {\rm V}$ |
| Delay Time | t _(d) | - | 300 | - | ns | |
| Rise Time | t _(r) | - | 292 | - | ns | $V_{CC} = 48V, I_C = 150mA,$ |
| Storage Time | t _(s) | - | 805 | - | ns | -I _{B2} = 1.5mA, V _{CE(ON)} = 0.15V |
| Fall Time | t _(f) | - | 226 | - | ns | |
| Storage Time | t _(s) | - | 25 | - | ns | $V_{CC} = 48V, I_C = 150mA,$ |
| Fall Time | t _(f) | - | 202 | - | ns | $-I_{B2} = 1.5 \text{mA}, V_{CE(ON)} = 4 \text{V}$ |

Notes: 7. Measured under pulsed conditions. Pulse width = 300μ s. Duty cycle $\leq 2\%$

Electrical Characteristics @T_A = 25°C unless otherwise specified



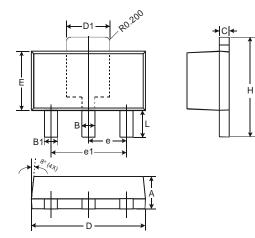






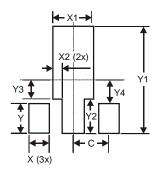


Package Outline Dimensions



| SOT89 | | | |
|-------|----------------------|------|--|
| Dim | Min | Max | |
| Α | 1.40 | 1.60 | |
| В | 0.44 | 0.62 | |
| B1 | 0.35 | 0.54 | |
| С | 0.35 | 0.43 | |
| D | 4.40 | 4.60 | |
| D1 | 1.52 | 1.83 | |
| Е | 2.29 | 2.60 | |
| е | 1.50 Typ | | |
| e1 | 3.00 Typ | | |
| Н | 3.94 | 4.25 | |
| L | 0.89 | 1.20 | |
| All [| All Dimensions in mm | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Х | 0.900 |
| X1 | 1.733 |
| X2 | 0.416 |
| Y | 1.300 |
| Y1 | 4.600 |
| Y2 | 1.475 |
| Y3 | 0.950 |
| Y4 | 1.125 |
| C | 1.500 |



ZXTN4000Z

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